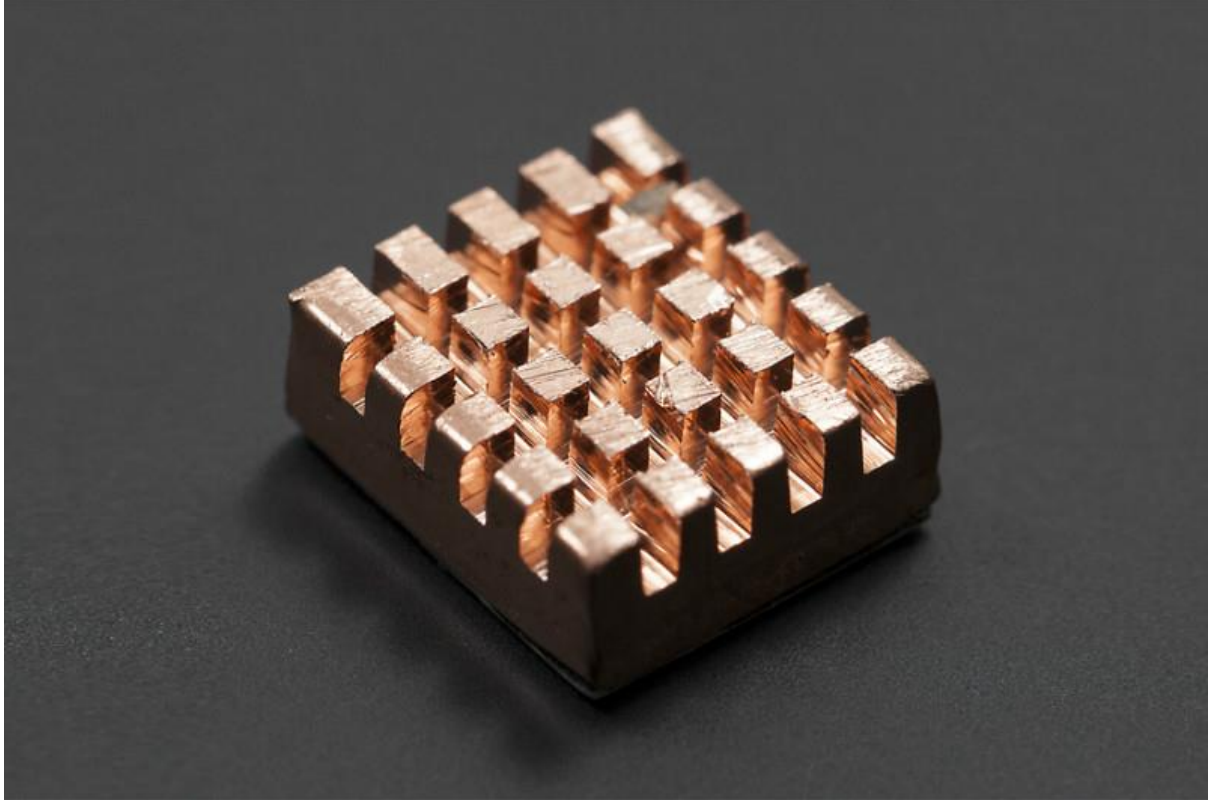




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Self-Adhesive Pure Copper Heatsink

SKU:FIT0367



INTRODUCTION

This high quality, low profile, pure copper heatsink is a perfect solution for cooling off small surface-mount components such as stepper motor drivers, SOCs or a [LattePanda](#). The pure copper increases heat dissipation and transfer to keep your device running cooler in warm environments.

APPLICATIONS

- Cooling for SBCs such as [LattePanda](#), [Raspberry Pi](#), etc.
- Compatible with other sensors or actuators such as high load motor controllers, stepper motors, stepper motor drivers etc.

SPECIFICATION

- Pure copper
- Self-adhesive
- Dimensions: 13.2mm x 12.1mm (0.52" x 0.48")
- Weight: 10g



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